

:	SPECIFICATIONS	
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# History of Version

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11/27/2007	01	001	New Sample	-	Tony
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Total : 31Pages



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### **1. SPECIFICATIONS**

#### 1.1 Features

Item	Standard Value
Display Type	240*128 dots
LCD Type	FSTN, Positive, Transflective, Extend Temp.
Driver Condition	LCD Module :1/160Duty,1/10Bias
Viewing Direction	6 O'clock
Backlight	White LED B/L
Weight	
Interface	Support 8 bit parallel interface with 8080 or 6800 series MPU
Other(controller / driver IC)	ST7529-G
	THIS PRODUCT CONFORMS THE ROHS OF PTC
ROHS	Detail information please refer web side :
	http://www.powertip.com.tw/news/LatestNews.asp

# 1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	99.2(L) * 64.2(W) * 5.4(H)	mm
Viewing Area	93.0(L) * 49.0(W)	mm
Active Area	82.775(L) * 44.135(W)	mm
Dot Size	0.32(L) * 0.32(W)	mm
Dot Pitch	0.345(L) * 0.345(W)	mm

Note : For detailed information please refer to LCM drawing

#### 1.3 Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit
Power Supply Voltage	V <sub>dd</sub>	_	-0.5	4.0	V
LCD Driver Supply Voltage	V <sub>LCD</sub>	_	-0.5	20	V
Input Voltage	V <sub>IN</sub>	_	-0.5	V <sub>DD</sub> +0.5	V
Operating Temperature	T <sub>OP</sub>	_	-20	70	°C
Storage Temperature	T <sub>ST</sub>	_	-30	80	°C
Storage Humidity	$H_{D}$	<b>Ta&lt;60</b> °C	-	90	%RH



#### **1.4 DC Electrical Characteristics**

		VI	<sub>DD</sub> =3.0±0.	3V , V <sub>SS =</sub>	=0V , Ta =	25℃
Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Logic Supply Voltage	V <sub>DD</sub>	-	2.7	3.0	3.3	V
"H" Input Voltage	V <sub>IH</sub>	-	$0.7V_{DD}$	-	V <sub>DD</sub>	V
"L" Input Voltage	V <sub>IL</sub>	-	V <sub>SS</sub>	-	$0.3V_{DD}$	V
"H" Output Voltage	V <sub>OH</sub>	-	-	-	-	V
"L" Output Voltage	V <sub>OL</sub>	-	-	-	-	v
		Vdd=3.0V, Vop: 12.95 V		0.10		
Secondar Communit	Ŧ	Pattern= Full OFF	-	0.12	-	
Supply Current	I <sub>DD</sub>	VDD=3.0V, VOP:12.95 V				mA
		Pattern= Full display *1		0.14	0.3	
		-20°C	13.50	13.65	13.80	
LCM Driver Voltage	V <sub>OP</sub> *2	25°C	12.80	12.95	13.10	V
		70°C	11.90	12.05	12.20	

NOTE: \*1 The maximum current display

\*2 The Vop test point is V0-Vss



### **1.5 Optical Characteristics**

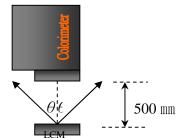
			LCD Pa	anel: 1/160	Duty, 1/13	Bias, V <sub>LCE</sub>	$_{0} = 15.0$ V	V, Ta = 25°C
Item	Item		Conditions	Min.	Тур.	Max.	Unit	Reference
Response Time	Rise	tr		-	135	205	ms	Note2
Response nine	Fall	tf		-	300	450	1115	NOLEZ
	Тор	θ <b>Υ+</b>	C <u>&gt;</u> 2.0,	+45	-	-		
Viewing angle	Bottom	θ <b>Υ-</b>	Ø =270	-40	-	-	Deg.	Notes 1
range	Left	⊖X-	-	R45		-		NOLES I
	Right	θ <b>X+</b>		L40	-	-		
Contrast Ra	tio	С	-	6	8	-	-	Note 3
Average Bright (with LCD)		IV		40	55	-	cd/m <sup>2</sup>	-
CIE Color Coor	CIE Color Coordinate		lf=80 mA	0.25	0.30	0.35		Note 4
(With LCD	)	Y		0.29	0.34	0.39		NOLE 4
Uniformity <sup>•</sup>	*1	∆B	-	70	-	-	%	-

Note 4 :

1 : △B=B(min) / B(max) \* 100%

- 2 : Measurement Condition for Optical Characteristics:
  - a : Environment: 25°C ±5°C / 60±20%R.H · no wind · dark room below 10 Lux at typical lamp current and typical operating frequency.
  - b : Measurement Distance: 500 ± 50 mm  $\rightarrow$  ( $\theta$ = 0°)
  - c : Equipment: TOPCON BM-7 fast , (field 1°) , after 10 minutes operation.
  - d: The uncertainty of the C.I.E coordinate measurement ±0.01 , Average Brightness ± 4%

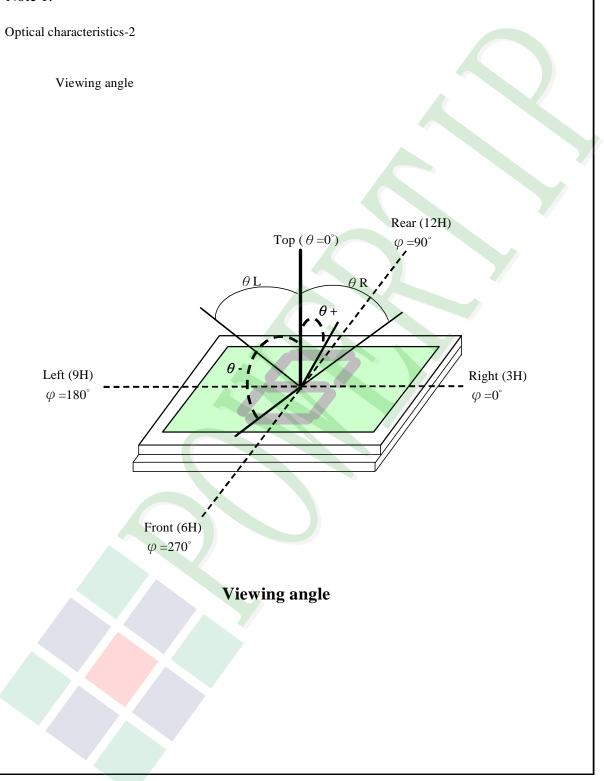




Colorimeter=BM-7 fast

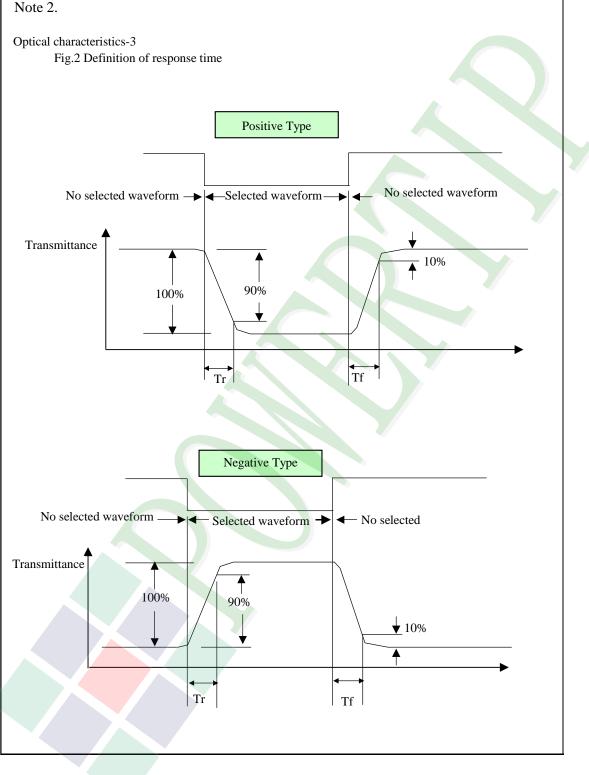




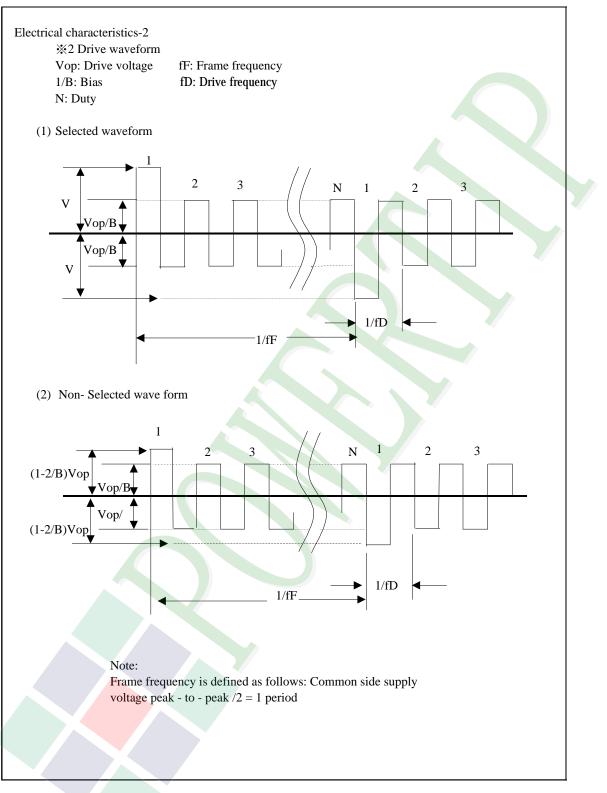




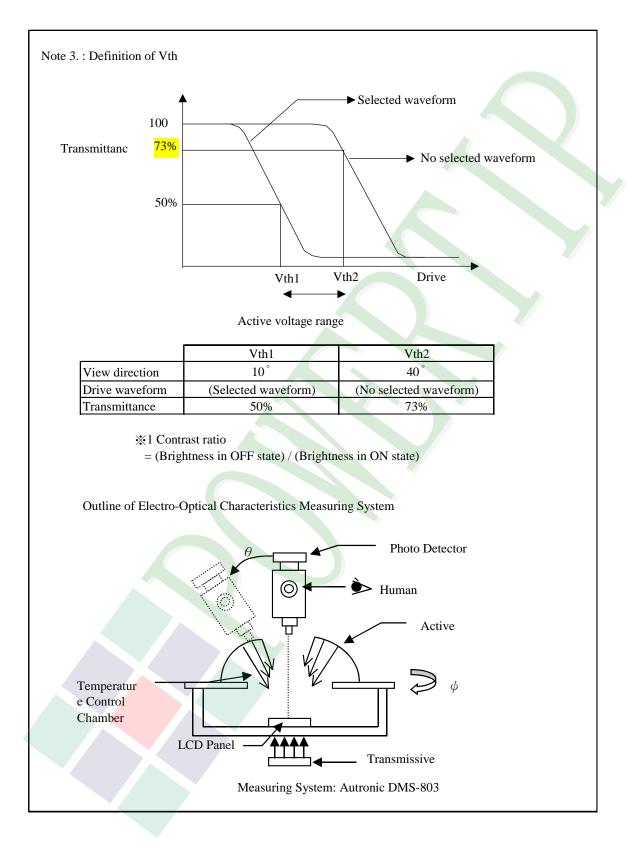














#### **1.6 Backlight Characteristics**

#### Electrical / Optical Characteristics

Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage	Vf		-	3.3	3.6	V
Average Brightness (Without LCD)	IV	lf=80 mA	176	220	1	cd/m <sup>2</sup>
Color			White			

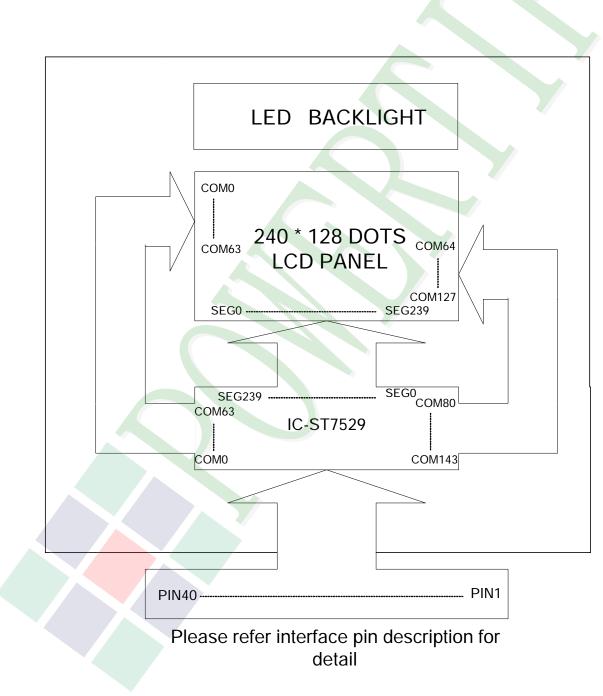


## 2. MODULE STRUCTURE

#### 2.1 Counter Drawing

#### 2.1.1 LCM Mechanical Diagram

- \* See Appendix
- 2.1.2 Block Diagram





## 2.2 Interface Pin Description

Pin No.	Symbol			Function				
1	AO	- A0 = "H": [	Register select input pin – A0 = "H": DB0 to DB8 or SI are display data – A0 = "L": DB0 to DB8 or SI are control data					
		Read / Write e	Read / Write execution control pin					
		MPU Type						
		6800	RW	Read / Write control input pin				
0				RW = "H" : read				
2	RW_WR			RW = "L" : write				
		8080	/WR	Write enable clock input pin				
				The data on DB0 to DB8 are latched at the				
				rising edge of the /WR signal.				
3	DB0							
4	DB1							
5	DB2	]						
6	DB3			ard 8-bit MPU bus via the 8 bit bi-directional bus				
7	DB4	J. J		elected and the XCS pin is high, the following pin hich should be fixed to VDD or VSS.	ns			
8	DB5	become nigh	impedance, v					
9	DB6							
10	DB7							
		Read / Write e	execution control	ol pin				
		MPU Type	RW_WR	Description				
		6800	E	Read / Write control input pin				
				-RW = "H": When E is "H", DB0 to DB8 are				
44				in an output status.				
11	E_RD			-RW = "L": The data on DB0 to DB8 are				
				latched at the falling edge of the E signal.				
		8080	/RD	Read enable clock input pin				
				When /RD is "L", DB0 to DB8 are in an				
				output status.				
12	RST	Reset input p	oin. When RS	T is "L", initialization is executed.				



Pin No.	Symbol			Function
13	IF1	IF1	IF3	MPU interface type
		H	L	80 series 8-bit parallel
14	IF3	L	Н	68 series 8-bit parallel
45	XCS	Chip select inpu	•	alad anhywhan XCC is "I " Whan shin salast is
15	703			bled only when XCS is "L". When chip select is a be high impedance.
16	VSS	Power supply (		ay be high impedance.
			•	
17	VDD	Power supply (	/DD=3.3V)	
18	CAP7P	DC / DC voltage	converter. C	onnect a capacitor between this terminal and
10		the $\leq$ 7X VLCD	; 8X CAP11	V terminal.
19	CAP1N	U U		onnect a capacitor between this terminal and
10	0,4 11	the $\leq$ 5X OPEN	; $\geq$ 6X also C	CAP5P; $\geq 8X$ also CAP7P terminal.
20	CAP5P	-		connect a capacitor between this terminal and
	0, 1, 0,	the $\leq$ 5X VLCD		
21	CAP3P	-		connect a capacitor between this terminal and
	0, 1, 0,	the $\leq 3X \text{ VLCD}$	$; \geq 4 \mathrm{X}  \mathrm{CAR}$	P1N1 terminal.
22	CAP1N1	-		onnect a capacitor between this terminal and
	<b>•</b> <i>i</i> • • • • • •	the CAP1P term		
23	CAP1P	-		connect a capacitor between this terminal and
		the CAP1N1 terr		
24	CAP2P	_		onnect a capacitor between this terminal and
		the 2X VLCD;		
25	CAP2N			connect a capacitor between this terminal and
		the $\leq 2X$ OPEN		
26	CAP4P			connect a capacitor between this terminal and
		the $\leq 4X$ VLCD		
27	CAP2N1	<u> </u>		connect a capacitor between this terminal and
		the $\leq 6X$ OPEN		
28	CAP6P	Ű.		connect a capacitor between this terminal and
		the $\leq 6X$ VLCD		
				or is used, connect to a stabilizing
		capacitor(1uF/25		
29	VLCD	÷		the external LCD supply voltage can be supplied
		-	-	ase, the internal voltage generator has to be
		programmed to z	ero(SET reg	ister VB=0). (Positive voltage:15 $\pm$ 0.5V)

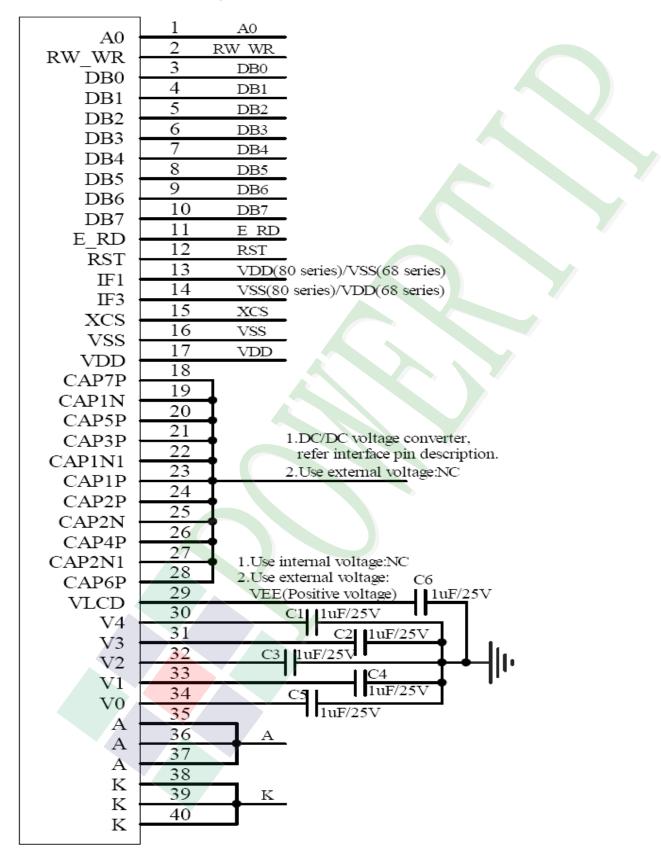


Pin No.	Symbol		Function						
30	V4	LCD driver sup V0In & V0out s	oply voltages should be conn	ected together	in FPC area.				
31	V3	$V0 \ge V1 \ge$	Voltages should have the following relationship: $V_0 \ge V_1 \ge V_2 \ge V_3 \ge V_4 \ge VSS$						
32	V2		When the internal power circuit is active, these voltages are generated as the following table according to the state of LCD bias.						
33	V1	LCD Bias	V1	V2	V3	V4			
34	V0	NOTE: N = 5 t	$1/N$ Bias $(N-1) / N \times VO (N-2) / N \times VO (2/N) \times VO (1/N) \times VO$ NOTE: N = 5 to 14Connnect capacitors(1uF/25V) between these terminals and GND.						
35~37	A	Power supply fo	or Backlight (and	de)					
38~40	к	Power supply fo	or Backlight (catl	node)					

NOTE:IF an external voltage supply is used on VLCD terminal,PIN18~28:Not connect.

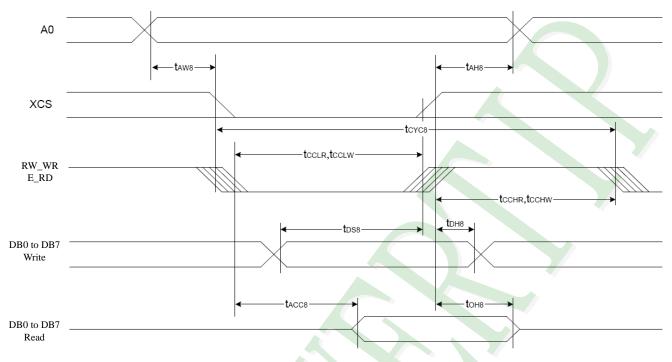


**Reference circuit for using LCM module:** 





### 2.3 Timing Characteristics For the 8080 Series MPU



 $V_{DD} = 3.3 V$ 

Item	Signal	Symbol	Condition	Rating		Units
nem	Signal	Symbol	Condition	Min	Max	Units
Address hold time		t <sub>AH8</sub>	-	20	-	
Address setup time	A0	t <sub>AW8</sub>	-	20	-	
System cycle time		t <sub>CYC8</sub>	-	200	-	
Enable L pulse width (Write)	RW WR	t <sub>CCLW</sub>	-	100	-	
Enable H pulse width (Write)		t <sub>CCHW</sub>	-	100	-	
Enable L pulse width (Read)	E_RD	t <sub>CCLR</sub>	-	100	-	ns
Enable H pulse width (Read)	L_ND	t <sub>CCHR</sub>	-	100	-	
WRITE Data setup time		t <sub>DS8</sub>	-	150	-	
WRITE Address hold time		t <sub>DH8</sub>	-	20	-	
READ access time	DB0 to DB7	t <sub>ACC8</sub>	$C_L=100pF$	-	40	
READ Output disable time		t <sub>OH8</sub>	$C_L=100pF$	I	30	



Item	Signal	Sumbol	Condition	Rat	ting	Units
nem	Signal	Symbol	Condition	Min	Max	UTIIIS
Address hold time		t <sub>AH8</sub>	-	20	-	
Address setup time	A0	t <sub>AW8</sub>	-	30	-	
System cycle time		t <sub>CYC8</sub>	-	250	-	
Enable L pulse width (Write)	RW WR	t <sub>CCLW</sub>	-	150	1	
Enable H pulse width (Write)		t <sub>CCHW</sub>	-	100	-	
Enable L pulse width (Read)	E RD	t <sub>CCLR</sub>	-	150	1	ns
Enable H pulse width (Read)		t <sub>CCHR</sub>		100		
WRITE Data setup time		t <sub>DS8</sub>	-	200	-	
WRITE Address hold time		t <sub>DH8</sub>		20	-	
READ access time	DB0 to DB7	t <sub>ACC8</sub>	$C_L=100pF$	-	40	
READ Output disable time		t <sub>OH8</sub>	$C_L=100pF$	-	30	

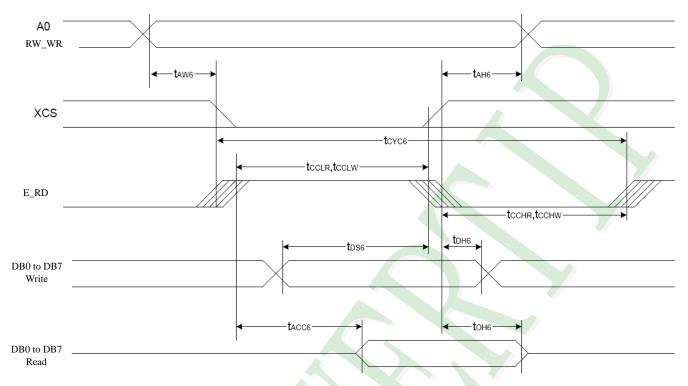
\*1 The input signal rise time and fall time (tr, tf) is specified at 15 ns or less. When the system cycle time is extremely fast,  $(tr + tf) \leq (tCYC8 - tCCLW - tCCHW)$  for  $(tr + tf) \leq (tCYC8 - tCCLR - tCCHR)$  are specified.

\*2 All timing is specified using 20% and 80% of VDD as the reference.

\*3 tCCLW and tCCLR are specified as the overlap between XCS being "L" and WR and RD being at the "L" level.



### For the 6800 Series MPU



 $V_{DD} = 3.3 V$ 

						22
ltem	Signal	Symbol	Condition	Rat	ting	Units
nem	Signal	Symbol	Condition	Min	Max	UTIILS
Address hold time		t <sub>AH6</sub>	-	20	-	
Address setup time	A0	t <sub>AW6</sub>	-	20	-	
System cycle time		t <sub>CYC6</sub>	-	200	-	
Enable L pulse width (Write)	RW_WR	tewlw	-	100	-	
Enable H pulse width (Write)		t <sub>EWHW</sub>	-	100	-	
Enable L pulse width (Read)	E_RD	t <sub>EWLR</sub>	-	100	-	ns
Enable H pulse width (Read)	L_ND	t <sub>EWHR</sub>	-	100	-	
WRITE Data setup time		t <sub>DS6</sub>	-	150	-	
WRITE Address hold time		t <sub>DH6</sub>	-	20	-	
READ access time	DB0 to DB7	t <sub>ACC6</sub>	$C_L=100pF$	-	40	
READ Output disable time		t <sub>OH6</sub>	$C_L=100pF$	-	30	



VDD=2.7V

Item	Signal	Symbol	Condition	Rat	ting	Units
nem	Signal	Symbol	Condition	Min	Max	Units
Address hold time		t <sub>AH6</sub>	-	20	-	
Address setup time	A0	t <sub>AW6</sub>	-	30	-	
System cycle time		t <sub>CYC6</sub>	-	250	-	
Enable L pulse width (Write)	RW WR	t <sub>EWLW</sub>	-	150	-	
Enable H pulse width (Write)		t <sub>EWHW</sub>	-	100	-	
Enable L pulse width (Read)	E RD	t <sub>EWLR</sub>	-	150	-	ns
Enable H pulse width (Read)		t <sub>EWHR</sub>		100	-	
WRITE Data setup time		t <sub>DS6</sub>		200	-	
WRITE Address hold time		t <sub>DH6</sub>	I	20	-	
READ access time	DB0 to DB7	t <sub>ACC6</sub>	$C_L=100pF$	-	40	
READ Output disable time		t <sub>OH6</sub>	C <sub>L</sub> =100pF	-	30	

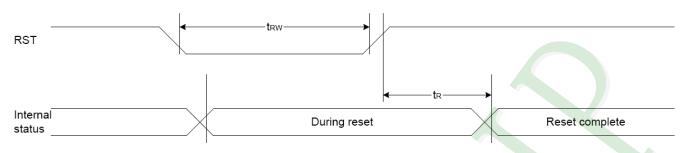
\*1 The input signal rise time and fall time (tr, tf) is specified at 15 ns or less. When the system cycle time is extremely fast,  $(tr + tf) \leq (tCYC6 - tEWLW - tEWHW)$  for  $(tr + tf) \leq (tCYC6 - tEWLR - tEWHR)$  are specified.

\*2 All timing is specified using 20% and 80% of VDD as the reference.

\*3 tEWLW and tEWLR are specified as the overlap between XCS being "L" and E.



#### **Reset Timing**



 $V_{DD} = 3.3V$ 

Itom	Signal	Symbol	Condition		Rating		Linita
Item	Signal	Symbol	Condition	Min	Тур	Max	Units
Reset time	-	t <sub>R</sub>		-	-	1	μs
Reset "L" pulse width	RST	t <sub>RW</sub>		1	-	-	μs

 $V_{DD} = 2.7 V$ 

						00	
Item	Signal	Symbol	Condition		Rating		Units
item	Signal	Symbol	Condition	Min	Тур	Max	Units
Reset time	-	t <sub>R</sub>		-	-	1.5	μs
Reset "L" pulse width	RST	t <sub>RW</sub>		1.5	-	-	μs



#### 2.4 Display Command

#### Ext=0 or Ext=1

Index	Command	A0	RD	WR	D7	D6	D5	D4	D3	D2	D1	DO	Function	Hex	Parameter
1	Ext In	0	1	0	0	0	1	1	0	0	0	0	Ext=0 Set	30	None
2	Ext Out	0	1	0	0	0	1	1	0	0	0	1	Ext=1 Set	31	None

#### Ext=0

Index	Command	A0	RD	WR	D7	D6	D5	D4	D3	D2	D1	D0	Function	Hex	Paramete
1	DISON	0	1	0	1	0	1	0	1	1	1	1	Display On	AF	None
2	DISOFF	0	1	0	1	0	1	0	1	1	1	0	Display Off	AE	None
3	DISNOR	0	1	0	1	0	1	0	0	1	1	0	Normal Display	A6	None
4	DISIN∀	0	1	0	1	0	1	0	0	1	1	1	Inverse Display	A7	None
5	COMSCN	0	1	0	1	0	1	1	1	0	1	1	COM Scan Direction	вв	1 byte
6	DISCTRL	0	1	0	1	1	0	0	1	0	1	0	Display Control	CA	3 bytes
7	SLPIN	0	1	0	1	0	0	1	0	1	0	1	Sleep In	95	None
8	SLPOUT	0	1	0	1	0	0	1	0	1	0	0	Sleep Out	94	None
9	LASET	0	1	0	0	1	1	1	0	1	0	1	Line Address Set	75	2 bytes
10	CASET	0	1	0	0	0	0	1	0	1	0	1	Column Address Set	15	2 bytes
11	DATSDR	0	1	0	1	0	1	1	1	7	0	0	Data Scan Direction	BC	3 bytes
12	RAMWR	0	1	0	0	1	0	1	1	1	0	0	Writing to Memory	5C	Data
13	RAMRD	0	1	0	0	1	0	1	1	1	0	1	Reading from Memory	5D	Data
14	PTLIN	0	1	0	1	0	1	0	1	0	0	0	Partial display in	A8	2 bytes
15	PTLOUT	0	1	0	1	0	1	0	1	0	0	1	Partial display out	A9	None
16	RMWIN	0	1	0	1	1	1	0	0	0	0	0	Read and Modify Write	E0	None
17	RMWOUT	0	1	0	1	1	1	0	1	1	1	0	RMW end	EE	None
18	ASCSET	0	1	0	1	0	1	0	1	0	1	0	Area Scroll Set	AA	4 bytes
19	SCSTART	0	1	0	1	0	1	0	1	0	1	1	Scroll Start Set	AB	1 byte
20	OSCON	0	1	0	1	1	0	1	0	0	0	1	Internal OSC on	D1	None
21	OSCOFF	0	1	0	1	1	0	1	0	0	1	0	Internal OSC off	D2	None
22	PWRCTRL	0	1	0	0	0	1	0	0	0	0	0	Power Control	20	1 byte
23	VOLCTRL	0	1	0	1	0	0	0	0	0	0	1	EC control	81	2 bytes
24	VOLUP	0	1	0	1	1	0	1	0	1	1	0	EC increase 1	D6	None
25	VOLDOWN	0	1	0	1	1	0	1	0	1	1	1	EC decrease 1	D7	None
26	RESERVED	0	1	0	1	0	0	0	0	0	1	0	Not Use	82	0
27	EPSRRD1	0	1	0	0	1	1	1	1	1	0	0	READ Register1	7C	None



28	EPSRRD2	0	1	0	0	1	1	1	1	1	0	1	READ Register2	7D	None
29	NOP	0	1	0	0	0	1	0	0	1	0	1	NOP Instruction	25	None
30	STREAD	0	0	1		•	F	Read	Dat	a	•		Status Read		
31	EPINT	0	1	0	0	0	0	0	0	1	1	1	Initial code(1)	07	1 byte

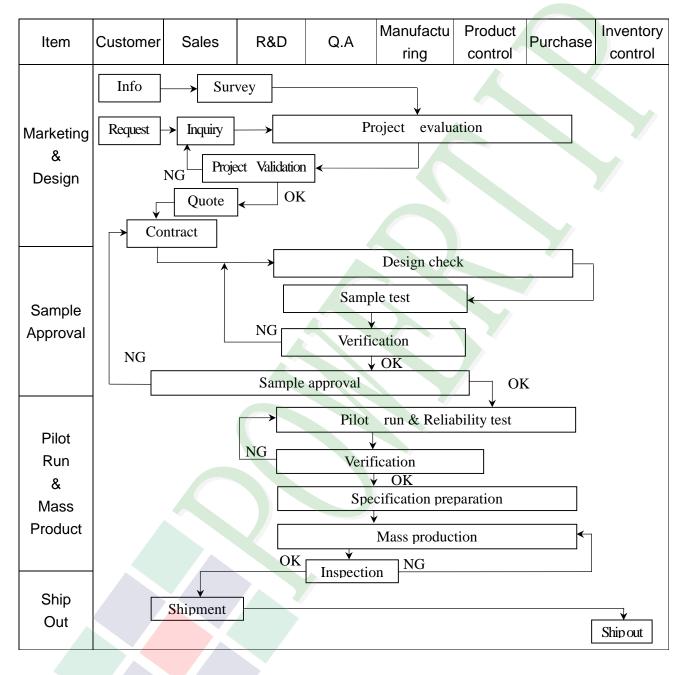
#### Ext=1

Index	Command	A0	RD	WR	D7	D6	D5	D4	D3	D2	D1	D0	Function	Hex	Parameter
1	Gray 1 Set	0	1	0	0	0	1	0	0	0	0	0	FRAME 1 Gray PWM Set	20	16 bytes
2	Gray 2 Set	0	1	0	0	0	1	0	0	0	0	1	FRAME 2 Gray PWM Set	21	16 bytes
3	Wt. Set	0	1	0	0	0	1	0	0	0	1	0	Weight Set	22	3 bytes
4	ANASET	0	1	0	0	0	1	1	0	0	1	0	Analog Circuit Set	32	3 bytes
5	DITHOFF	0	1	0	0	0	1	1	0	1	0	0	Dithering Circuit Off	34	None
6	DITHON	0	1	0	0	0	1	1	0	1	0	1	Dithering Circuit On	35	None
7	EPCTIN	0	1	0	1	1	0	0	1	1	0	1	Control EEPROM	CD	1 byte
8	EPCOUT	0	1	0	1	1	0	0	1	1	0	0	Cancel EEPROM	СС	None
9	EPMWR	0	1	0	1	1	1	1	1	1	0	0	Write to EEPROM	FC	None
10	EPMRD	0	1	0	1	1	1	1	1	1	0	1	Read from EEPROM	FD	None



## **3. QUALITY ASSURANCE SYSTEM**

### 3.1 Quality Assurance Flow Chart





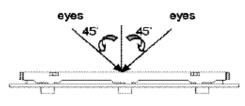
Item	Customer	Sales	R&D	Q.A	Manufact	Product	Purchase	Inventory
nem	Cusiomer	Sales	NQD	Q.A	uring	control	Fulchase	control
Sales Service	Info	➤ Claim →	[	Trackin	Failure an Corrective			
Q.A Activity	1. ISO 900 3. Equipme 5. Standard		on	4.	Process in Education			es

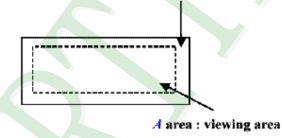


#### **3.2 Inspection Specification**

◆Inspection Standard : MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.

- ◆Equipment : Gauge、MIL-STD、Powertip Tester、Sample
- ◆Defect Level : Major Defect AQL 0.4; Minor Defect AQL 1.5 .
- OUT Going Defect Level : Sampling .
- ◆Manner of appearance test :
  - (1). The test be under  $40W \times 2$  fluorescent light ' and distance of view must be at 30 cm.
  - (2). The test direction is base on about around  $45^{\circ}$  of vertical line. (Fig. 1)
  - (3). Definition of area . (Fig. 2)





B area : Outside of viewing area

#### • Specification:

NO	Item	Criterion	level
		1.1 The part number is inconsistent with work order of Production.	Major
01	Product condition	1.2 Mixed production types.	Major
		1.3 Assembled in inverse direction.	Major
02	Quantity	2.1 The quantity is inconsistent with work order of production.	Major
03	Outline dimension	3.1 Product dimension and structure must conform to Structure diagram.	Major
		4.1 Missing line character \ dot and icon.	Major
04	Electrical Testing	4.2 No function or no display.	Major
		4.3 Output data is error.	Major
		4.4 LCD viewing angle defect.	Major
		4.5 Current consumption exceeds product specifications.	Major
05	Black or white dot < scratch < contamination Round type	<ul> <li>5.1 Round type:</li> <li>5.1.1 display only : <ul> <li>White and black spots on display ≤ 0.30mm, no more than Four white or black spots present.</li> <li>Densely spaced : NO more than two spots or lines within 3mm</li> </ul> </li> </ul>	Minor



-	ecification :	0.14						1 1
NO 05	Item	Criterion						level
05	Black or white dot $\$ scratch $\$ contamination Round type $\mathbf{x}$ $\mathbf{y}$ $\mathbf{y}$ $\Phi = (x+y)/2$	$ \begin{array}{c c} \hline 0.10i \\ 0.20i \\ \hline \end{array} $ 5.1.3 Line type $ \begin{array}{c c} \hline Dimension \\ Length \\ \hline \hline \\ L \leq 3.0 mm \\ 0.10i \\ \hline \end{array} $	hsion (diameter $\Phi \leq 0.10$ mm $nm < \Phi \leq 0.20$ $nm < \Phi \leq 0.30$ Total e: (diameter : $\Phi$ ) width $w \leq 0.03$ mm $03$ mm $< \Phi \leq 0$	mm mm )	Acc A area Accept no de	nse 3 2 4 eptanc	re (Q'ty) B area Don't count Don't count	Minor
	→ <u>1</u> ←	L≦2.5mm 0. 	$\frac{05\text{mm} < \Phi \leq 0}{\text{w} > 0.075\text{m}}$		4 As	round	Don't count l type	
06	Polarizer Bubble	Dimension (di $\Phi \leq 0$ . 0.20mm < $\Phi$ 0.50mm < $\Phi$ $\Phi > 1$ . Total q	$20 \text{mm}$ $D \leq 0.50 \text{mm}$ $D \leq 1.00 \text{mm}$ $00 \text{mm}$ $uantity$		Acceptance area ept no dense 3 2 0 4		y) B area Don't count Don't count Don't count Don't count Don't count	Minor
07	The crack of glass	Glass Cra 7.1 Crack of Front	ack: on the circuit of $X \le 1/5$		le terminal : $\frac{Y}{Y \le 1/2 \text{ D}}$	2	$\frac{Z}{Z \leq t}$	Minor
		Back		1	Neglect			



	ecification :					
NO	Item	Criterion				Level
		<ul> <li>Glass Crack</li> <li>7.2 General gla</li> <li>7.2.1</li> </ul>		corner edge:	Z	
	The crack of glass		X	Y	Z	Minor
				Out A area	Neglect	
	X: The length of Crack		<u> </u>			
	Y: The width of crack	7.2.2		STEP.		
			A Contraction of the second	12 A		
07	Z: The thickness of crack					
	D: terminal length		X glect	Y Out A area	Z Neglect	
	T: The thickness of glass					
	A : The length of glass	7.3 Glass remain:				
			$\mathbb{X}$			Minor
			X Negleo		Y 1/3 d	



Specification : NO Item Criterion Level 7.4 Corner crack and medial crack: The crack of glass X: The length of Crack Y: The width of crack 07 Z: The thickness of Minor crack [NG] (OK) D: terminal length T: The thickness of glass Х Y Ζ  $\leq 1/5a$  $\leq 1/2t$ A : The length of Crack can't enter viewing area glass Crack can't exceed the half of  $\leq 1/5a$  $1/2t < Z \leq 2t$ width of SP width of SP 8.1 Backlight can't work normally. Major 8.2 Backlight doesn't light or color is wrong. Major Backlight 08 elements 8.3 Illumination source flickers when lit. Major 9.1 pin type must match type in specification sheet Major 9.2 No short circuits in components on PCB or FPC Major 9.3Product packaging must the same as specified on General Major 09 appearance packaging specification sheet. 9.4 The folding and peeled off in polarizer are not Major acceptable 9.5 The PCB or FPC between B/L assembled distance Major (PCB or FPC) is  $\leq 1.5$ mm



## 4. RELIABILITY TEST

#### 4.1 Reliability Test Condition

	TEST ITEM	TECT CONDITION					
NO.	TEST ITEM	TEST CONDITION					
1	High Temperature Storage Test	Keep in 80 $\pm 2^{\circ}$ C 96 hrs					
			rrounding temperature, then storage at normal condition 4hrs				
2	Low Temperature Storage Test	Keep in $-30 \pm 2^{\circ}$ C 96 hrs					
		Surrounding temperature, then storage at normal condition 4hrs					
2	High Humidity Storage	Keep in $+60^{\circ}$ C/90% RH duration for 96 hrs					
3	High Humidity Storage	Surrounding temperature, then storage at normal condition 4hrs					
		(Excluding the polarizer)					
		Air Discharge:	Contact Discharge:				
		Apply 2 KV with 5 times	Apply 250V with 5 times				
		Discharge for each polarity +/-	discharge for each polarity +/-				
		1. Temperature Ambient: $15^{\circ}$ C ~ 35	°℃				
		2. Humidity relative: $30\% \sim 60\%$					
4	ESD Test	3. Energy Storage Capacitance(Cs+Cd):150pF±10%					
		4. Discharge Resistance(Rd):330 Ω	2±10%				
		5. Discharge, mode of operation:					
		Single Discharge (time between successive discharges at least 1 s)					
		(Tolerance If the output voltage indication: $\pm 5\%$ )					
		$-20^{\circ}\text{C} \rightarrow 25^{\circ}\text{C} \rightarrow 70^{\circ}\text{C} \rightarrow 25^{\circ}\text{C}$					
5	Toma anothing Civilia a Toot	(30mins) (5mins) (30mins) (5mins)					
5	Temperature Cycling Test	↓ 10 Cycle					
		Surrounding temperature, then storage at normal condition 4hrs					
		1. Sine wave $10 \sim 55$ HZ frequency (1 min)					
6	Vibration Test (Packaged)	<ol> <li>2. The amplitude of vibration :1.5 mm</li> </ol>					
		<ol> <li>The amplitude of violation 11.5 min</li> <li>Each direction (XYZ) duration for 2 Hrs</li> </ol>					
		Packing Weight (Kg)	Drop Height (cm)				
		0 ~ 45.4	122				
7		45.4 ~ 90.8	76				
	Drop Test (Packaged)	90.8 ~ 454	61				
		Over 454	46				
		Drop direction : %3 come	r /1 edges /6 sides etch 1times				



## **5. PRECAUTION RELATING PRODUCT HANDLING**

### **5.1 SAFETY**

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes , please wash it off immediately by using soap and water.

### **5.2 HANDLING**

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module , be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So, please handle it very carefully ,do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands , this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is  $320\pm10^{\circ}$ C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM .

### **5.3 STORAGE**

- 5.3.1 Store the panel or module in a dark place where the temperature is  $25^{\circ}C \pm 5^{\circ}C$  and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush , shake , or jolt the module.

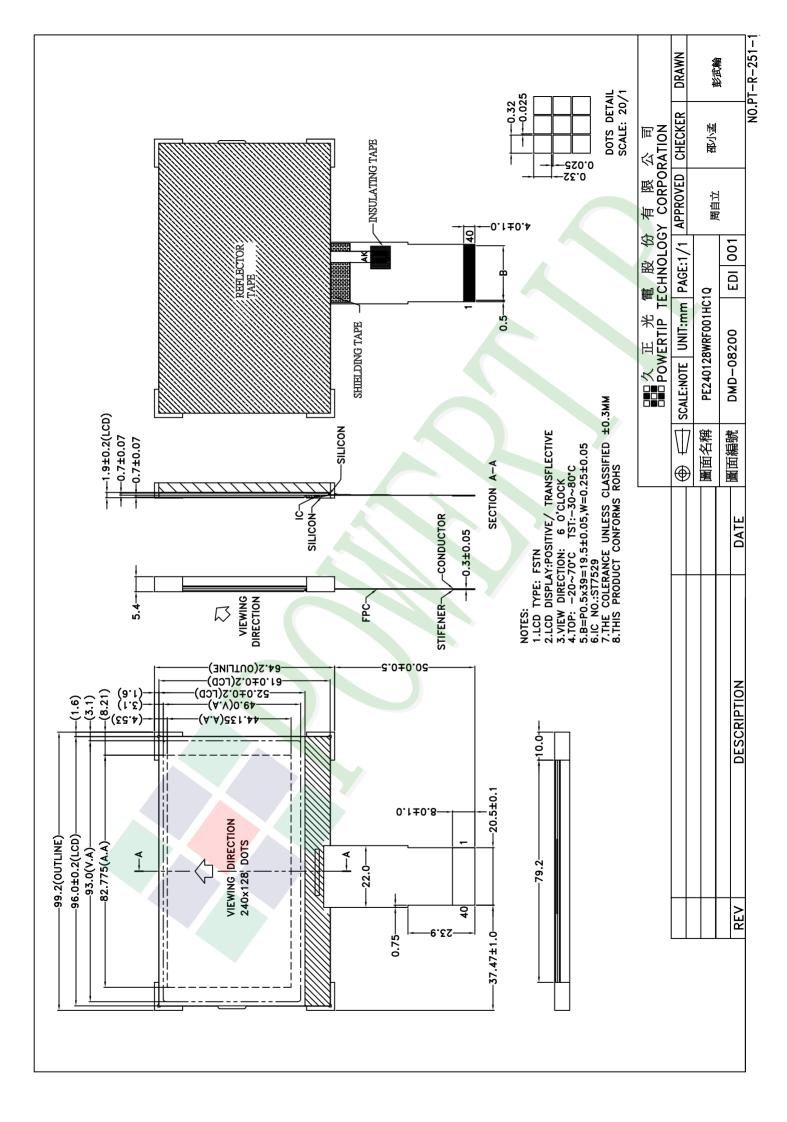
#### **5.4 TERMS OF WARRANTY**

5.4.1 Applicable warrant period

The period is within thirteen months since the date of shipping out under normal using and storage conditions.

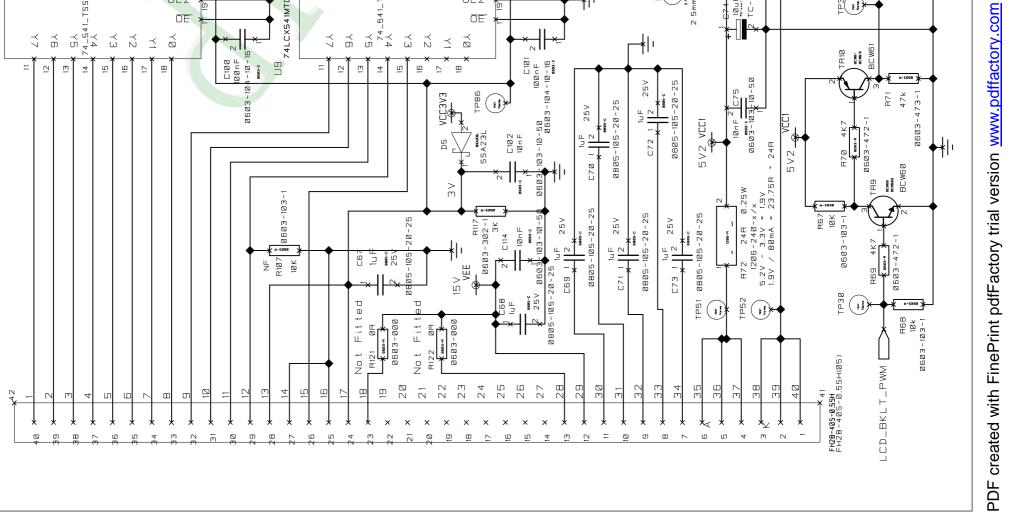
5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.





	A **** 29.05.08 FS	ISSUE C.N. DATE DRAWN CHKD.	TITLE LCD Level Shifter	DRG NQ A A B B B B 10 f 1 SCALE	JSTICS PORTMANMOOR RD. IND. ESTCARDIFF. TEL. (029) 20485885 HUNTLEIGH TECHNOLOGY PLC 2001. ALL RIGHTS RESERVED. NO PART OF GEPRODUCED STORED ON A RETRIEVAL SYSTEM. TRANSMITTED IN ANY FORM OR BY ANY PHOTOCOPYING OR OTHERWISE WITHOUT PRIOR PERMISSION OF THE COPYRIGHT OWNER.
	TOLERANCE X±0.5, X.X d=3, X.X 0.15	UNLESS OTHERWISE STATEI	MATERIAL	FINISH	CHUNTLEIGH DIAGNOSTICS PORTMANMOOR RD. THIS DRAWING MAY BE REPRODUCED, STORED ON A REI MEANSELECTRONIC.MECHANICAL, PHOTOCOPYING OR OTHERWI
HOLL DIMENSIONS IN MM A3 US ALLCHANTE	Z TC-IB6-16-18-A				



SCALE

DRG No. AAABBB DO NOT

L C D C O N 6

// ST7529 240x128 LCD	
// initial ST7529	
LCD_Write_Com(0x30);	// EXT=0
LCD_Write_Com(0xD1);	// INTERNAL OSCILLATION ON
LCD_Write_Com(0x94);	// SLEEP OUT

// DISPLAY CONTROL(CL,DUTY,FR)
// CL DIVIDING RATIO(CLD=0)
// DRIVE DUTY(1/160 = 160/4 -1=39)
// FR INVERSE-SET VALUE
// COMMON SCAN DIRECTON
// SET COM0->COM79,COM159->COM80

LCD_Write_Com(0x81);	// ELECTRONIC VOLUME CONTROL
LCD_Write_Data(CONS50); //	Vop=??.?V or SETTING VOLUME VALUE
LCD_Write_Data(CONS86); //	SETTING BUILT-IN RESISTANCE VALUE
LCD_Write_Com(0x20);	// POWER CONTROL SET
LCD_Write_Data(0x03);	// Regulator, Follower ON, external 15V
LCD_Write_Com(0xA7);	// Inverse Display
LCD_Write_Com(0xA9);	// PARTIAL OUT

LCD_Write_Com(0xBC);	// DATA SCAN
LCD_Write_Data(0x02);	// NORMAL/IN\
	ADDRESS SC

LCD\_Write\_Data(0x01); LCD\_Write\_Data(0x02);

// DATA SCAN DIRECTION
// NORMAL/INVERSE DISPLAY OF (THE LINE AND
ADDRESS SCAN DIRECTION
// NOT USED,D0 MUST BE 0
// GRAY-SCALE SETUP(3B3P MODE) as per V1.6 on-line
//spec

LCD\_Write\_Com(0x75); LCD\_Write\_Data(0x00); LCD\_Write\_Data(159);

LCD\_Write\_Com(0x15); LCD\_Write\_Data(5); LCD\_Write\_Data(0x54); // END LINE SET 159 // COLUMN ADDRESS SET

// LINE ADDRESS SET

// START LINE SET 00

// START COLUMN SET 00 // END COLUMN SET 255/3=85

LCD\_Write\_Com(0x31); // EXT=1 SET

LCD\_Write\_Com(0x32);

LCD\_Write\_Data(0x01);

LCD\_Write\_Data(0x04);

LCD\_Write\_Com(0x34);

LCD\_Write\_Com(0x30);

- // Analog circuit set LCD\_Write\_Data(0x00);
  - // OSC Frequency
  - // Booster Set
  - // Bias Set 1/10
  - // Software Initial / (Dithering OFF ?)
  - // EXT=0
- LCD\_Write\_Com(0xAF); // DISPLAY ON